

Implementation of Charged Dust Dynamics in a Spacecraft Contamination Code

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SCTC

16th Spacecraft Charging
Technology Conference

April 4-8, 2022



USC Viterbi
School of Engineering

Background

- Since 2015, PIC-C has been developing a 3D “mesh-free” particle tracing code for modeling molecular and particulate transport called CTSP
 - Brieda, L., J. Spacecraft & Rockets, Vol. 56, No. 2, 2019
- CTSP can support highly realistic geometries represented using surface meshes, TSS assemblies, and (future work) CAD analytical surfaces
- Majority of work to date involved neutral, collisionless molecular and particulate flows, although the code supports loading external electric field and including DSMC collisions
- We have recently started new effort to expand code capability to simulate charge propagation and finite-sized dust grains

Hello World

- A "Hello World" example of molecular transport on a generic satellite
- CAD model from GrabCAD, meshed in Pointwise
- Assigned outgassing source to antenna adapter
- Octree storage for surface mesh, mesh-free particle push
- Volumetric mesh used to visualize contamination plume

```
#simulation options
options{num_threads:1, file_diag_freq:1}

#load surface mesh
surface_load_unv{file_name:"satellite.unv",view:1}

#define volume mesh for computing contaminant plume
volume_mesh{dx:0.02,dy:0.02,dz:0.02,expand:[0.5,0.5,0.5]}

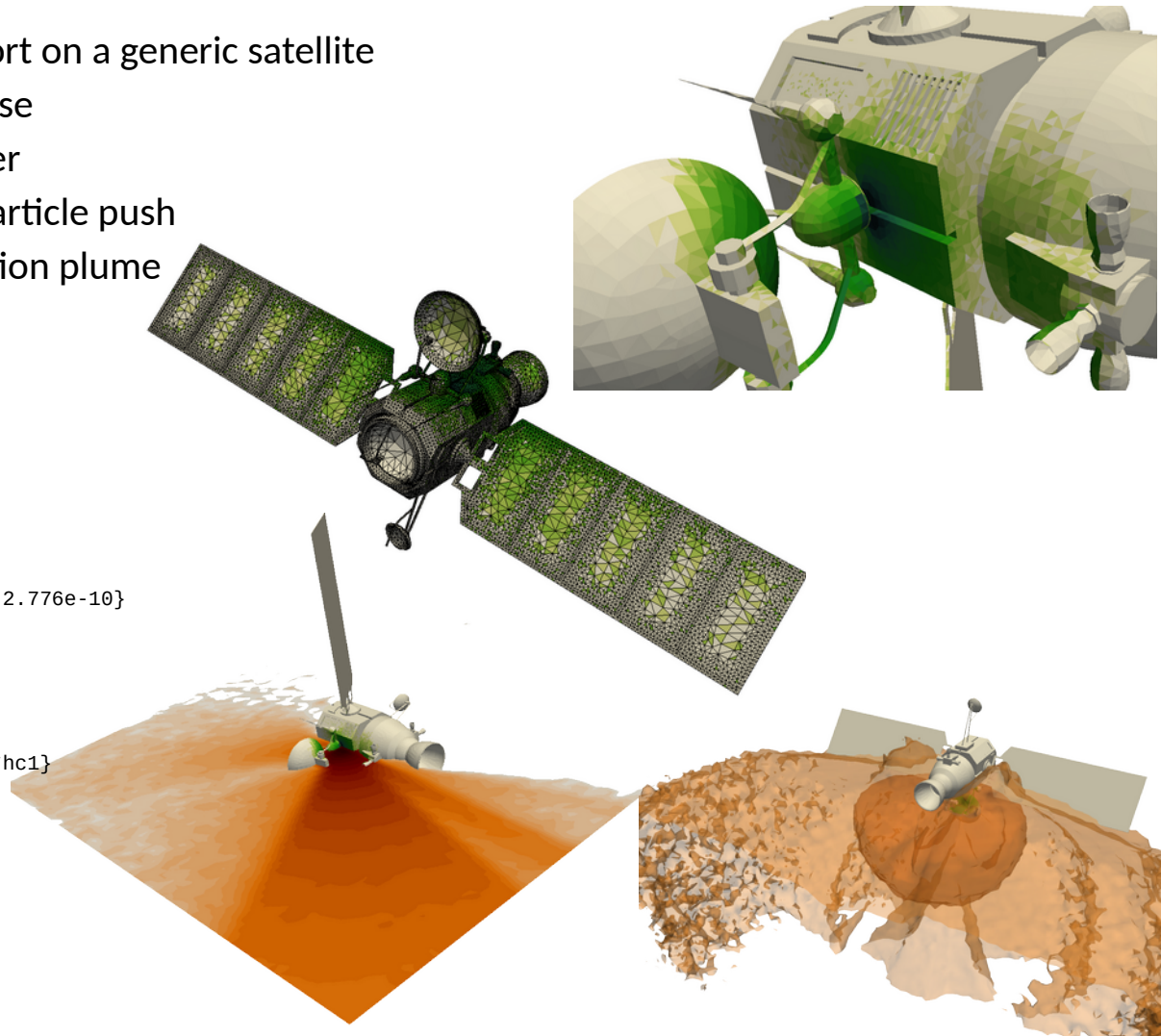
#specify materials
solid_mat{name:blanketing, weight: 100}
molecular_mat{name:hc1, weight: 54, mpw: 1e8, Ea:12, C_exp:100, r:2.776e-10}

#specify surface properties
surface_props{comps:./.*/, mat:blanketing, temp:260, c_stick:0.3}
surface_props{comps:source, temp:1000, c_stick:0}

#enable outgassing
load_molecules{comps:source, trapped_mass:1e-10, trapped_mats:1.0*hc1}
source_outgassing{model:"exp"}

#run simulation
run_sim{dt:1e-5,num_ts:5000,diag_start:5,diag_skip:5}

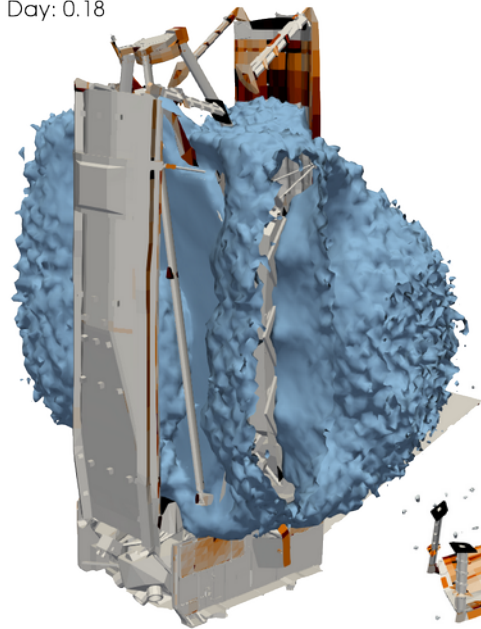
#save results
volume_save_vtk{skip:5000,file_name:"field",vars:[nd.hc1]}
surface_save_vtk{skip:5000,file_name:"surf"}
```



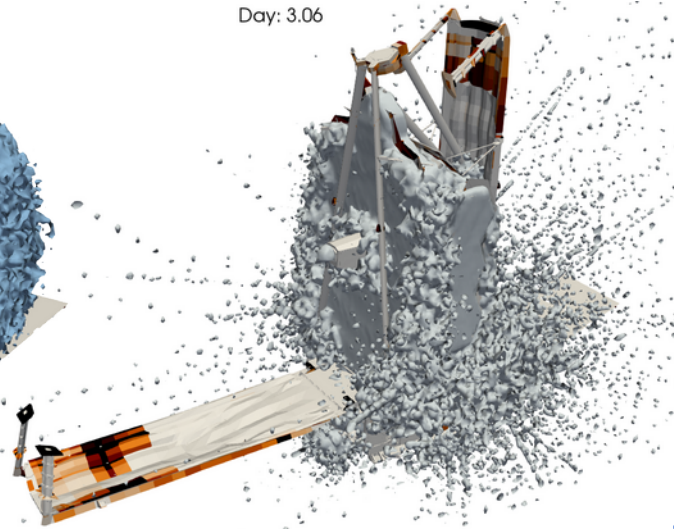
Deployment

- Recently also incorporated support to run analysis across varying geometrical configurations
- Allowed us to model evolution of water ice accumulation during JWST deployment: more details to be presented at SPIE Optics and Photonics in August 2022.

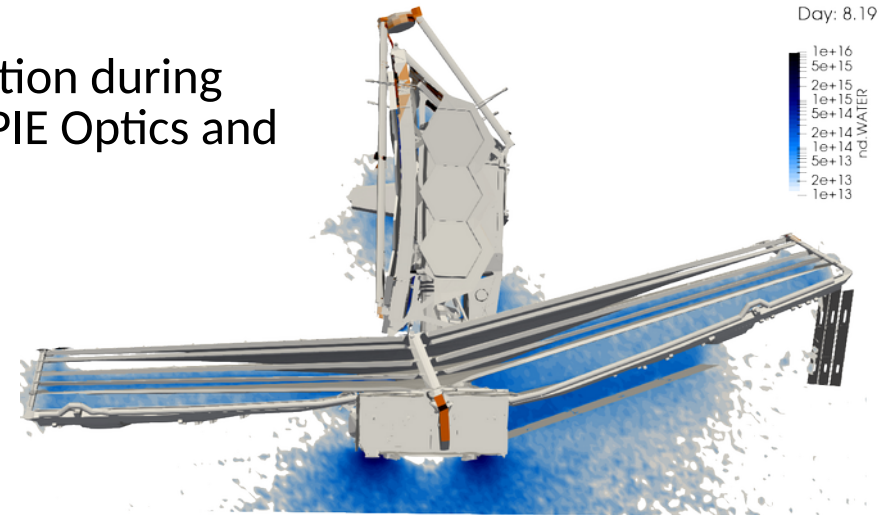
Day: 0.18



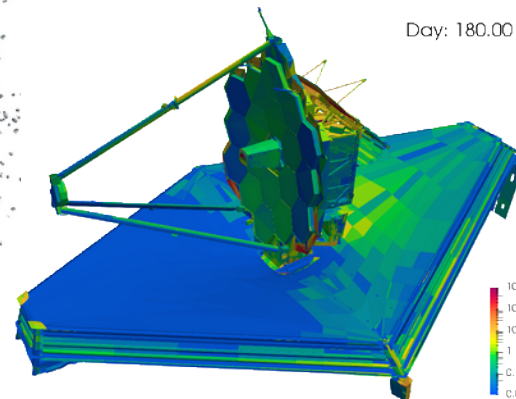
Day: 3.06



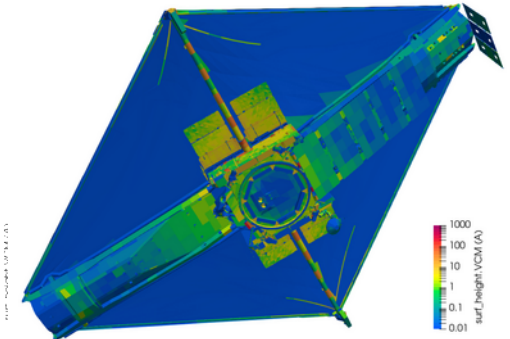
Day: 8.19



Day: 180.00

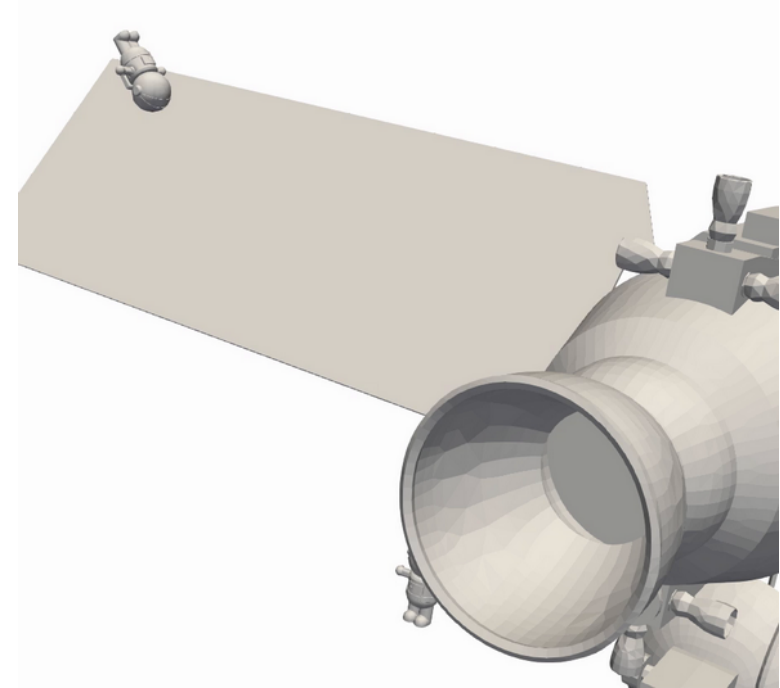
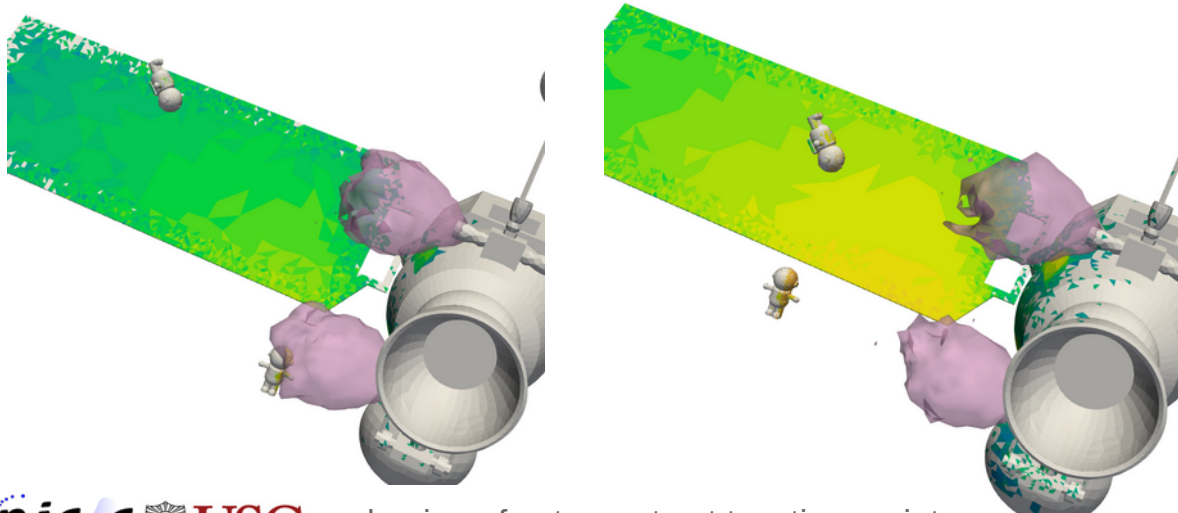


Day: 180.00



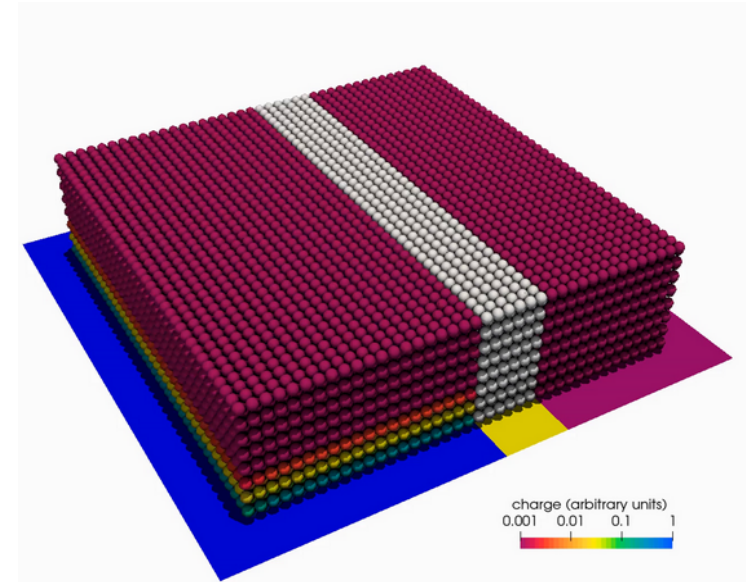
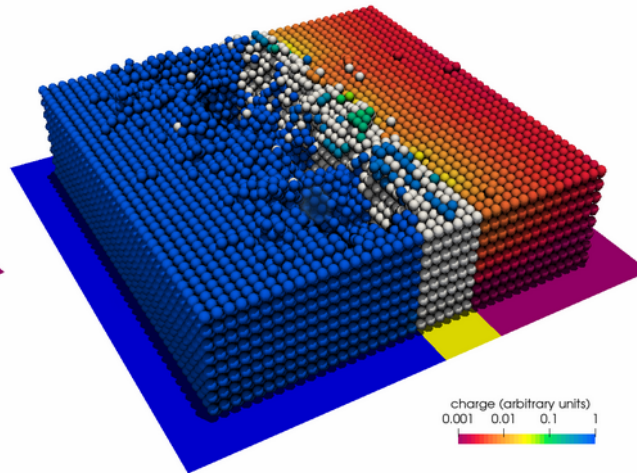
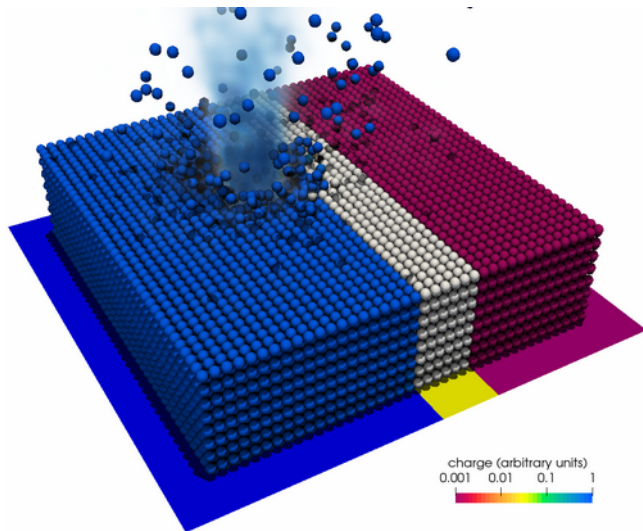
Surface Dynamics

- The JWST analysis considered 17 distinct geometries, restart file used to transfer solution between configuration changes
- Not robust enough to model servicing or lunar operations, recently implemented rudimentary support to include translating objects
- Each “actor” stored within own octree, transformation matrices map from global to local tree coordinates



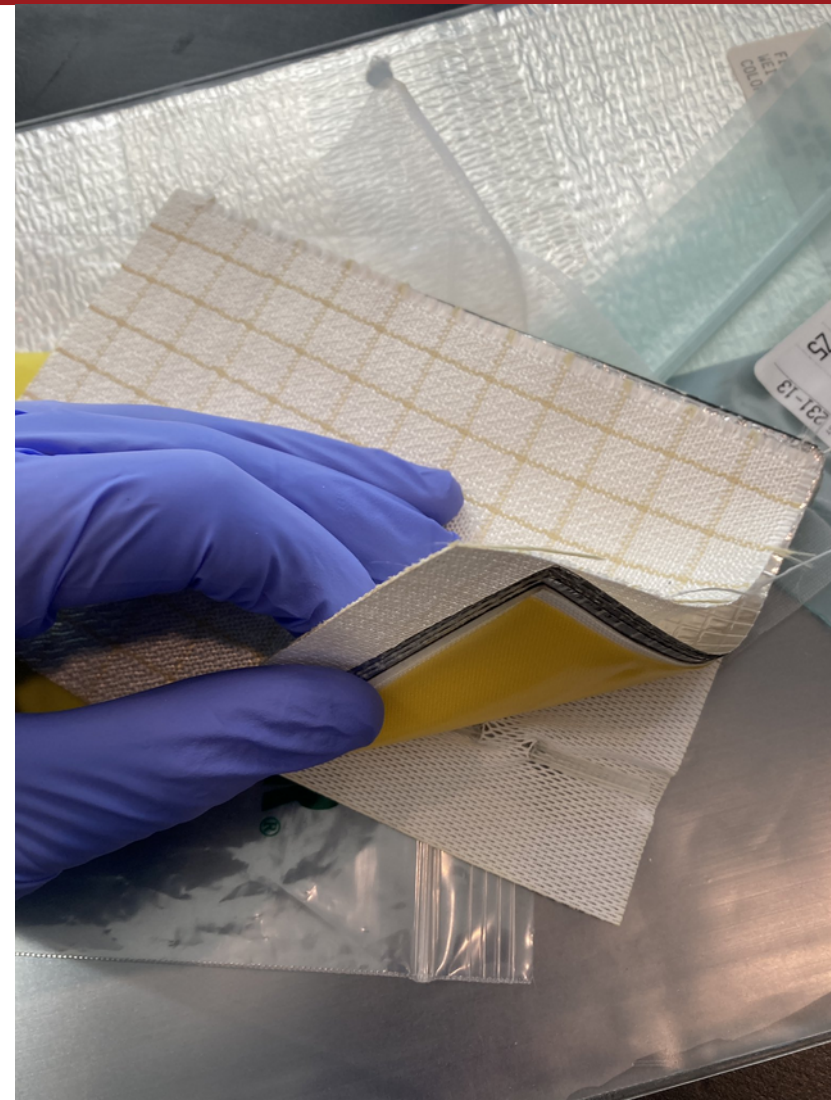
Charge Propagation Model

- Also developed a standalone model of charge propagation and dynamic surface evolution due to plasma interaction
- Example shows build up of a conductive bridge across an insulator due to arc mass ejection



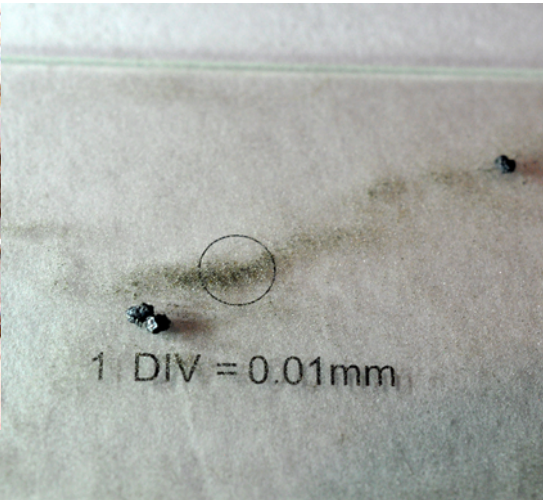
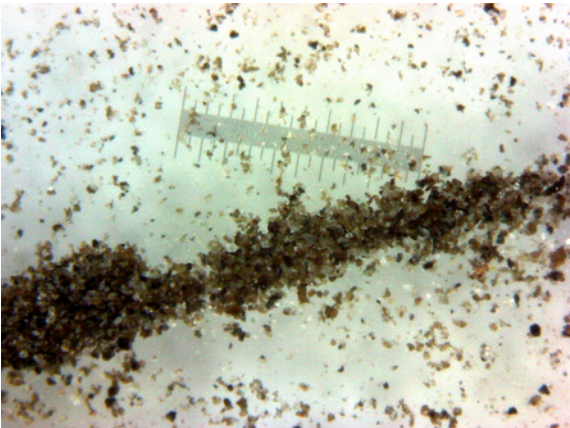
Motivation

- As demonstrated by others (including USC group), lunar regolith is expected to easily charge up due to photoelectron emission, with the charge profile being highly specific on the local environment
- Lunar regolith also sticky and may be hard to remove from surfaces, including astronaut spacesuits
- Our goal is to develop simulation capability that can resolve regolith accumulation and transport on engineering scales while retaining realistic level of detail and is backed by experimental validation

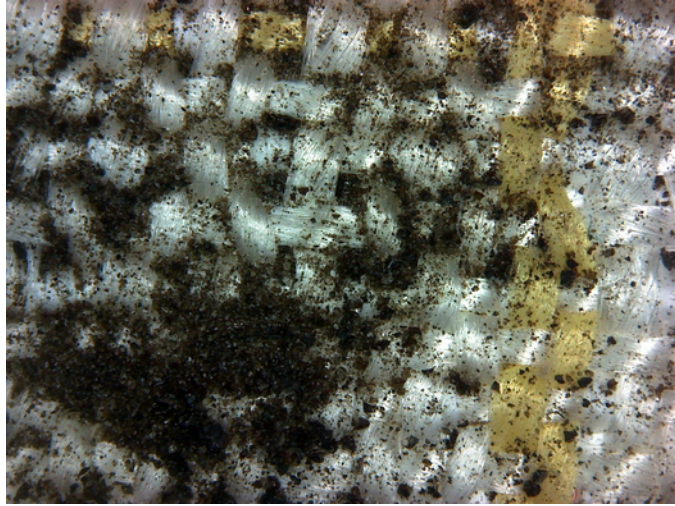


Regolith Sample

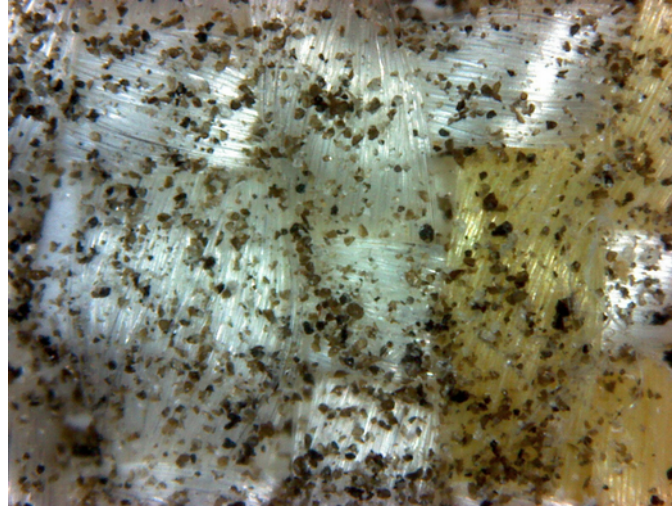
- Working with USC students to characterize regolith adhesion
- Utilizing JSC-1 simulant
- Microscope imaging indicates two distinct populations
- Fine dust ~ 50 micron



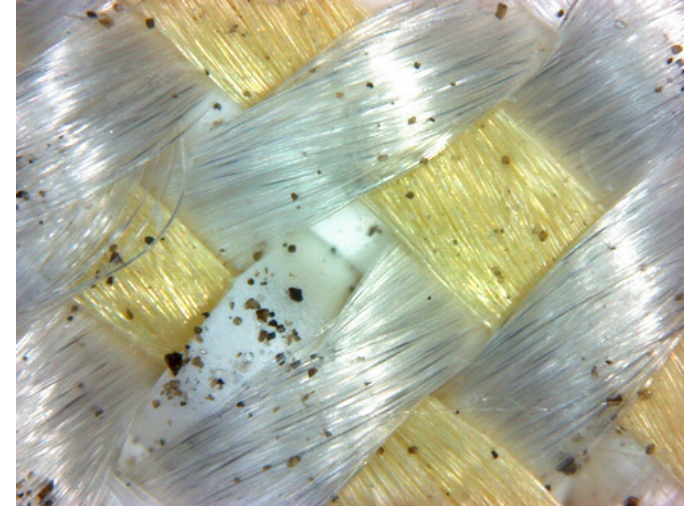
Desired Outcome



application



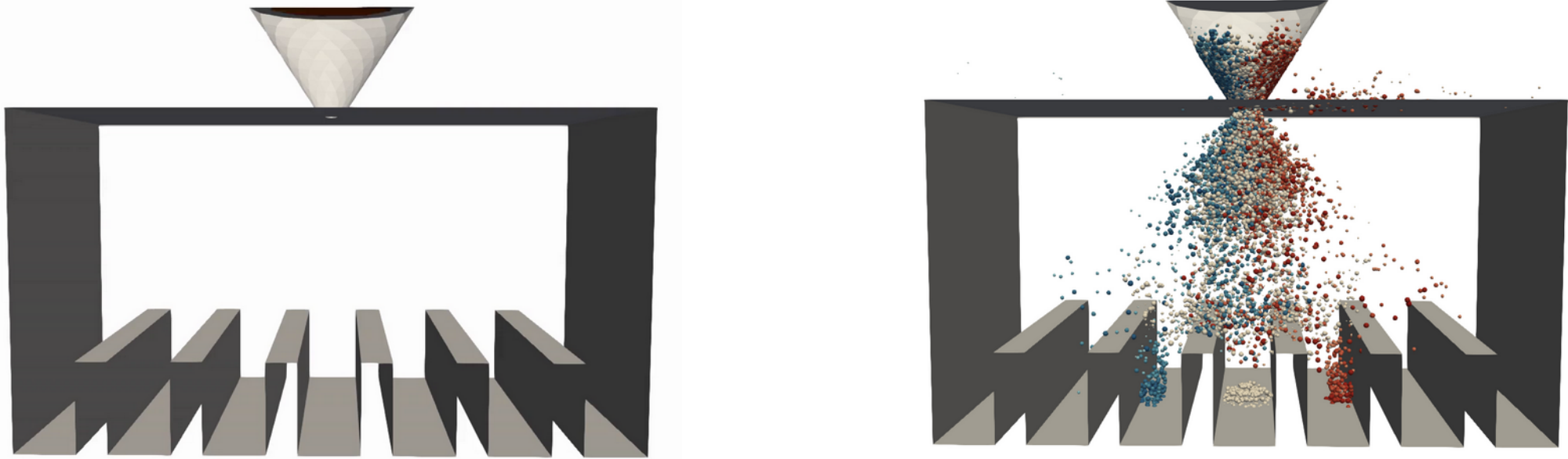
post shake



post brushing

Desired outcome: ability to simulate dynamic evolution of surface accumulation taking into account electrostatic attraction

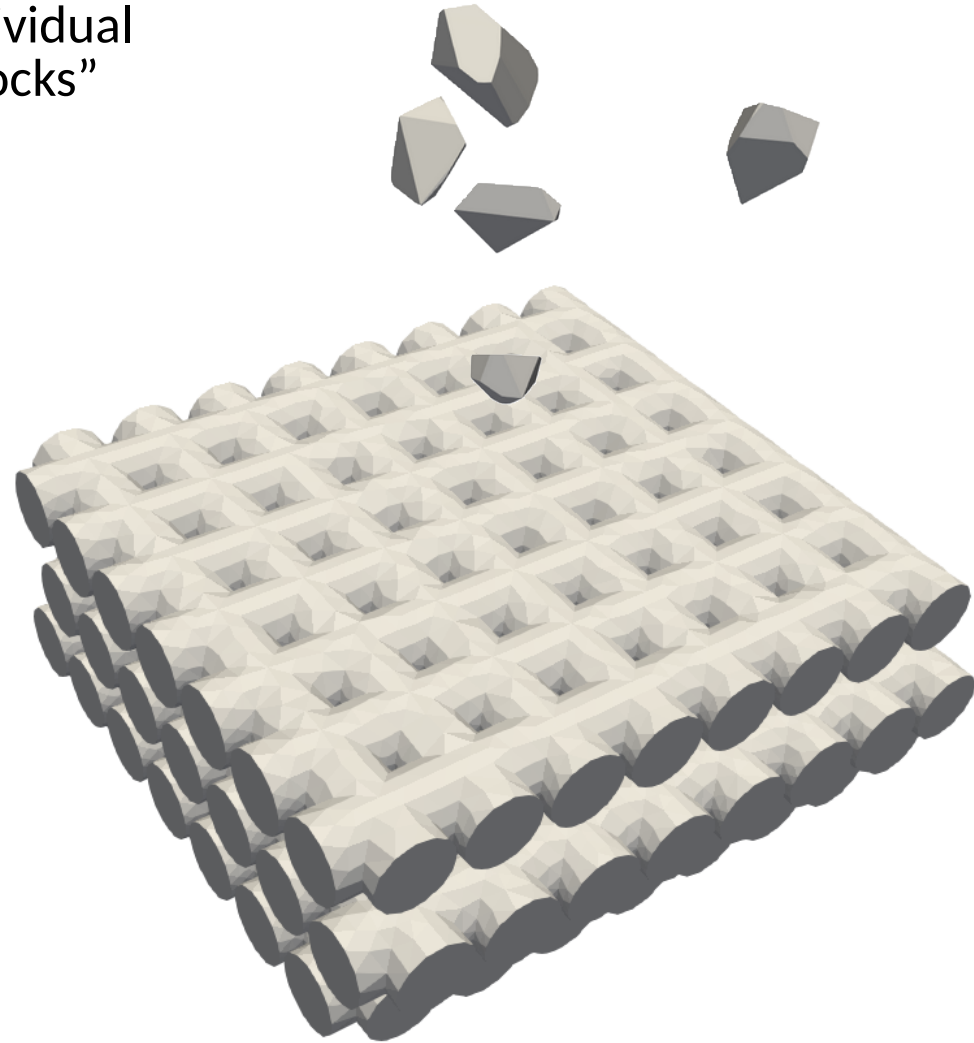
Charged Dust Propagation



- CTSP already contains support to model dust propagation under external electric field. Above animation shows sorting of grains of different charge/mass ratios. “Particle leaks” due to mesh error.
- However, dust simulated as point-size particles of finite mass / volume, no grain-grain interactions
- Not robust enough to model dust grain interactions within engineering configurations

Numerical Details (Future Work)

- Implementing support to model grains as individual tessellated surfaces, generated as random “rocks”
- Each grain represented by individual actor
- Surface charge stored per surface cell, charge propagation within and between grains based on specified capacitance
- Velocity updated from Coulomb force (N^2 scaling to be addressed using octree)
- Grains moved by shifting center of mass position – translation matrix
- Angular velocity modifies rotation matrix
- Implementing triangle-triangle intersection algorithm to detect surface impacts
- Multithreading to speed up computation



Conclusion

- New effort to expand capabilities of in-house contamination code to model transport of finite sized dust grains, specifically as applicable to lunar regolith space suite adhesion
 - Complemented with experimental testing using JSC-1 and a space suite sample at atmospheric condition
 - Future work involves experimental study of adhesion in vacuum environment with ambient plasma
 - Numerical and experimental results to be presented at next SCTC
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- Contact: lubos.brieda@particleincell.com
brieda@usc.edu

